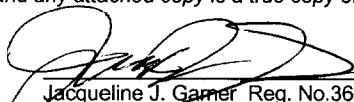


MRD 6-3-99

06-21-1999

FORM PTO-1595		U.S. Department of Commerce Patent and Trademark Office	
TI-22819		101071433	
To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.			
1. Name of conveying party(ies): 1) H.T. Wang 2) C.S. Fong 3) J.S. Hsu 4) C.Y. Tseng		2. Name and Address of receiving party(ies): Name: TEXAS INSTRUMENTS INCORPORATED Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265 Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
3. Nature of Conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other _____ Execution Date: June 17, 1998, June 18, 1998, June 15, 1998, June 23, 1998			
4. Application number(s) or patent number(s). <input checked="" type="checkbox"/> This document is being filed together with a new application. Execution date of the application: June 17, 1998, June 18, 1998, June 15, 1998, June 23, 1998 Title: EDGE BOND PADS ON INTEGRATED CIRCUIT Docket No: TI-22819 09324943 A. Patent Application No.(s) S.N. Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No B. Patent No.(s) Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No			
5. Name and address of party to whom correspondence concerning document should be mailed: Name: Jacqueline J. Garner Texas Instruments Incorporated Address: P.O. Box 655474, MS 3999 City: Dallas State: TX Zip: 75265		6. Number of applications and patents involved: <u>(1)</u> 7. Amount of fee enclosed or authorized to be charged: \$40 8. Deposit Account No: 20-0668 (Duplicate copies not required).	
06/16/1999 DALEXAND 00000030 200668 09324943 DO NOT USE THIS SPACE 02 FC:581 40.00 CH			
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. <u>6/3/99</u> Date  Jacqueline J. Garner Reg. No.36,144			

PATENT
REEL: 010029 FRAME: 0030

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

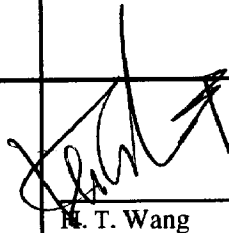
WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with its principal office at 13500 North Central Expressway, Dallas, Texas 75265, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	EDGE BOND PADS ON INTEGRATED CIRCUIT		
SIGNATURE OF INVENTOR AND NAME	 H. T. Wang		
DATE	6/17/88		
RESIDENCE (City, County, State)	4F, No. 8 Lane 21, FU-KUEI St. Fsin-Tien, Taipei Hsien, Taiwan, R.O.C		
DATE APPLICATION EXECUTED			

After recording returning Assignment to:

Texas Instruments Incorporated
P.O. BOX 655474, M/S 3999
DALLAS, TX 75265

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

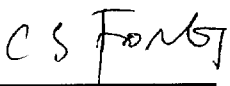
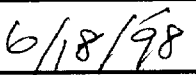
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TITLE OF INVENTION	EDGE BOND PADS ON INTEGRATED CIRCUIT		
SIGNATURE OF INVENTOR AND NAME	 C. S. Fong		
DATE			
RESIDENCE (City, County, State)	4FL 54-3 :ame 3. Sec/ 2 Chiong Shun Rd., Chung Ho, Taipei Hsien, Taiwan, R.O.C.		
DATE APPLICATION EXECUTED			

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TITLE OF INVENTION	EDGE BOND PADS ON INTEGRATED CIRCUIT		
SIGNATURE OF INVENTOR AND NAME	 J. S. Hsu		
DATE	6/15/98		
RESIDENCE (City, County, State)	4F · No. 5-1, Alley 7, Line 257, Sec 1 Lilung St Taipei , Taiwan, R.O.C.		
DATE APPLICATION EXECUTED			

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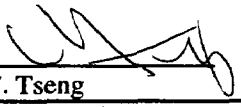
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TITLE OF INVENTION	EDGE BOND PADS ON INTEGRATED CIRCUIT		
SIGNATURE OF INVENTOR AND NAME	 C. Y. Tseng		
DATE	6/23/88		
RESIDENCE (City, County, State)	3F, No. 15 Lane 11, Chi Ching St. Shin Tein City, Taipei Hsien, Taiwan R.O.C.		
DATE APPLICATION EXECUTED			

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